

Vishay Siliconix

# N-Channel 30-V (D-S) MOSFET

# PowerPAK® 1212-8SH D D D D 8 D D 8 S S S S S

#### Top View Bottom View

PRODUCT SUMMARY	
V <sub>DS</sub> (V)	30
$R_{DS(on)}$ max. ( $\Omega$ ) at $V_{GS} = 10 \text{ V}$	0.0075
$R_{DS(on)}$ max. ( $\Omega$ ) at $V_{GS} = 4.5 \text{ V}$	0.0098
Q <sub>g</sub> typ. (nC)	10.2
I <sub>D</sub> (A)	35 <sup>a, g</sup>
Configuration	Single

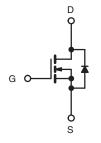
#### **FEATURES**

- TrenchFET® power MOSFET
- 100 % R<sub>g</sub> and UIS tested
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>



### **APPLICATIONS**

• Synchronous rectification



N-Channel MOSFET

ORDERING INFORMATION	
Package	PowerPAK 1212-8
Lead (Pb)-free and halogen-free	SiSH114ADN-T1-GE3

PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-source voltage		V <sub>DS</sub>	30	V	
Gate-source voltage		V <sub>GS</sub>	± 20		
Continuous drain current (T <sub>J</sub> = 150 °C)	T <sub>C</sub> = 25 °C		35 <sup>g</sup>		
	T <sub>C</sub> = 70 °C		35 <sup>g</sup>		
	T <sub>A</sub> = 25 °C	l <sub>D</sub>	18 <sup>b, c</sup>	^	
	T <sub>A</sub> = 70 °C		14.5 <sup>b, c</sup>	A	
Pulsed drain current		I <sub>DM</sub>	60		
Avalanche current	1 01	I <sub>AS</sub>	30		
Avalanche energy L = 0.1 mH		E <sub>AS</sub>	45	mJ	
Continuous accuracy during displace accuracy.	T <sub>C</sub> = 25 °C		32	Δ.	
Continuous source-drain diode current	T <sub>A</sub> = 25 °C	I <sub>S</sub>	3.2 <sup>b, c</sup>	Α	
	T <sub>C</sub> = 25 °C		39		
Adv. Co	T <sub>C</sub> = 70 °C		25	W	
Maximum power dissipation	T <sub>A</sub> = 25 °C	P <sub>D</sub>	3.7 <sup>b, c</sup>		
	T <sub>A</sub> = 70 °C	1	2.4 <sup>b, c</sup>		
Operating junction and storage temperature range		T <sub>J</sub> , T <sub>stg</sub>	-55 to +150		
Soldering recommendations (peak temperature) d, e			260	°C	

THERMAL RESISTANCE RATING	GS				
PARAMETER		SYMBOL	TYPICAL	MAXIMUM	UNIT
Maximum junction-to-ambient b, f	t ≤ 10 s	$R_{thJA}$	26	34	°C/W
Maximum junction-to-case (drain)	Steady state	$R_{thJC}$	2.4	3.2	C/ VV

#### Notes

- a. Based on T<sub>C</sub> = 25 °C
- b. Surface mounted on 1" x 1" FR4 board
- c. t = 10 s
- d. See solder profile (www.vishay.com/doc?73257). The PowerPAK 1212-8 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection
- e. Rework conditions: manual soldering with a soldering iron is not recommended for leadless components
- f. Maximum under steady state conditions is 81 °C/W
- g. Package limited

S18-1166-Rev. A, 26-Nov-2018

# Vishay Siliconix

PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT	
Static							
Drain-source breakdown voltage	V <sub>DS</sub>	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	30	-	-	V	
V <sub>DS</sub> temperature coefficient	$\Delta V_{DS}/T_{J}$	I <sub>D</sub> = 250 μA	-	33	-	mV/°C	
$\Delta V_{GS(th)}$ temperature coefficient $\Delta V_{GS(th)}/T_J$		I <sub>D</sub> = 250 μA	-	-6	-	mv/-C	
Gate-source threshold voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_D = 250 \mu A$	1.2	-	2.5	V	
Gate-source leakage	I <sub>GSS</sub>	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$	-	-	± 100	nA	
Zero gete voltege drain current		$V_{DS} = 30 \text{ V}, V_{GS} = 0 \text{ V}$	-	-	1	μΑ	
Zero gate voltage drain current	I <sub>DSS</sub>	$V_{DS} = 30 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 55 ^{\circ}\text{C}$	-	-	5		
Drain aguras en etete registance à	В	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 18 A	-	0.0062	0.0075	5 Ω	
Drain-source on-state resistance a	R <sub>DS(on)</sub>	$V_{GS} = 4.5 \text{ V}, I_D = 16 \text{ A}$	-	0.0081	0.0098	\$2	
Forward transconductance a	g <sub>fs</sub>	V <sub>DS</sub> = 15 V, I <sub>D</sub> = 18 A	-	50	-	S	
Dynamic <sup>b</sup>							
Input capacitance	C <sub>iss</sub>		-	1230	-		
Output capacitance	Coss	$V_{DS} = 15 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$	-	275	-	pF	
Reverse transfer capacitance	C <sub>rss</sub>		-	105	-	1	
<b>+</b>		$V_{DS} = 15 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 19 \text{ A}$	-	21	32		
Total gate charge	$Q_g$		-	10.2	20	0	
Gate-source charge	$Q_{gs}$	$V_{DS} = 15 \text{ V}, V_{GS} = 4.5 \text{ V}, I_{D} = 19 \text{ A}$	-	3.9	-	nC	
Gate-drain charge	$Q_{gd}$		-	3.2	-		
Gate resistance	$R_g$	f = 1 MHz	0.3	1.6	3.2	Ω	
Turn-on delay time	t <sub>d(on)</sub>		-	20	30		
Rise time	t <sub>r</sub>	$V_{DD}$ = 15 V, $R_L$ = 1.5 $\Omega$	-	14	21		
Turn-off delay time	t <sub>d(off)</sub>	$I_D\cong 10$ A, $V_{GEN}=4.5$ V, $R_g=1$ $\Omega$	-	20	30		
Fall time	t <sub>f</sub>		-	10	20	ns	
Turn-on delay time	t <sub>d(on)</sub>		-	11	20		
Rise time	t <sub>r</sub>	$V_{DD}$ = 15 V, $R_L$ = 1.5 $\Omega$	-	8	16		
Turn-off delay time	t <sub>d(off)</sub>	$I_D\cong 10$ A, $V_{GEN}=10$ V, $R_g=1$ $\Omega$	-	20	30		
Fall time	t <sub>f</sub>			7	14		
<b>Drain-Source Body Diode Characterist</b>	ics						
Continuous source-drain diode current	I <sub>S</sub>	T <sub>C</sub> = 25 °C	-	-	32	Λ.	
Pulse diode forward current	I <sub>SM</sub>		-	-	60	Α	
Body diode voltage	$V_{SD}$	I <sub>S</sub> = 10 A, V <sub>GS</sub> = 0 V	-	0.8	1.2	V	
Body diode reverse recovery time	t <sub>rr</sub>		-	24	36	ns	
Body diode reverse recovery charge	Q <sub>rr</sub>	$I_F = 10 \text{ A}, \text{ di/dt} = 100 \text{ A/}\mu\text{s},$	-	20	30	nC	
Reverse recovery fall time	ta	T <sub>J</sub> = 25 °C	-	16	-		
Reverse recovery rise time	t <sub>b</sub>		-	8	-	ns	

#### Notes

- a. Pulse test; pulse width  $\leq 300~\mu s,~duty~cycle \leq 2~\%$
- b. Guaranteed by design, not subject to production testing

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

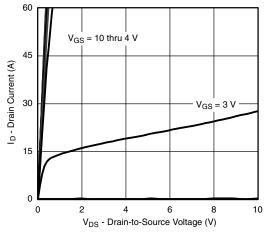


0.012

R<sub>DS(on)</sub> - On-Resistance (Ω) 00 90 60 60

0.003

## TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



#### **Output Characteristics**

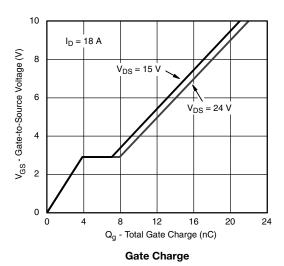
 $V_{GS} = 4.5 \text{ V}$ 

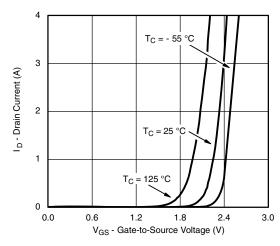
 $V_{GS} = 10 \text{ V}$ 



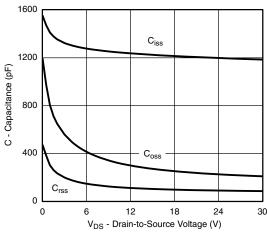
 $\label{eq:local_D} {\rm I_D} \cdot {\rm Drain} \; {\rm Current} \; ({\rm A})$  On-Resistance vs. Drain Current and Gate Voltage

80

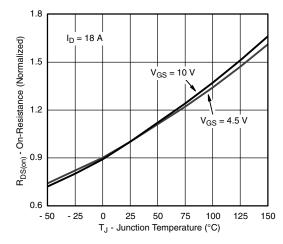




**Transfer Characteristics** 



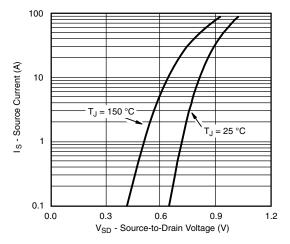
Capacitance



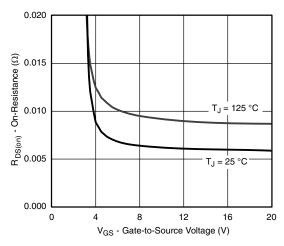
On-Resistance vs. Junction Temperature



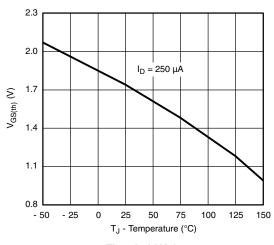
## TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



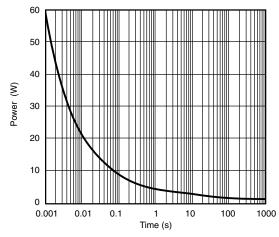
#### Source-Drain Diode Forward Voltage



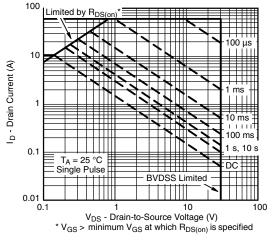
On-Resistance vs. Gate-to-Source Voltage



**Threshold Voltage** 



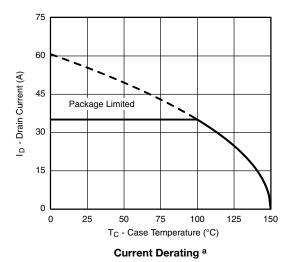
Single Pulse Power (Junction-to-Ambient)

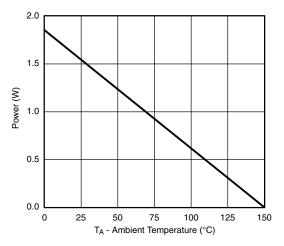


Safe Operating Area, Junction-to-Ambient



## TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)





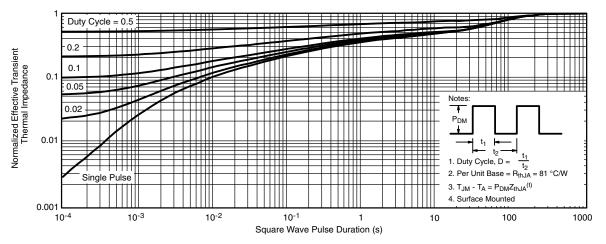
Power Derating, Junction-to-Ambient

#### Note

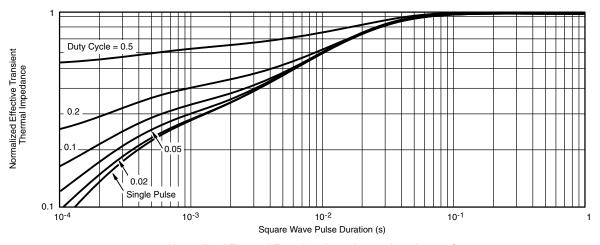
a. The power dissipation P<sub>D</sub> is based on T<sub>J</sub> max. = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.



## TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient

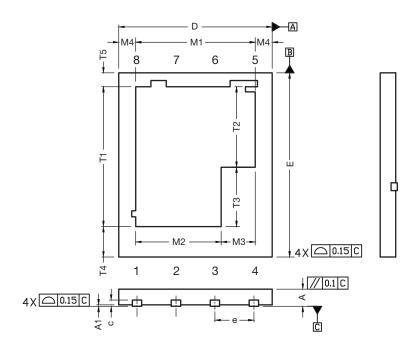


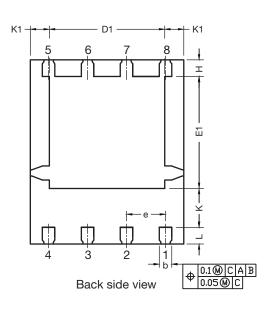
Normalized Thermal Transient Impedance, Junction-to-Case

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package / tape drawings, part marking, and reliability data, see <a href="https://www.vishay.com/ppg?75172">www.vishay.com/ppg?75172</a>.

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# PowerPAK® SO-8 Double Cooling Case Outline





DIM.	MILLIMETERS			INCHES			
	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.	
Α	0.51	0.56	0.61	0.012	0.014	0.016	
A1	0.00	0.02	0.05	0.000	0.0008	0.002	
b	0.36	0.41	0.46	0.014	0.016	0.018	
С	0.15	0.20	0.25	0.006	0.008	0.010	
D	4.90	5.00	5.10	0.193	0.197	0.201	
D1	3.71	3.76	3.81	0.146	0.148	0.150	
е		1.27 BSC			0.050 BSC		
Е	5.90	6.00	6.10	0.232	0.236	0.240	
E1	3.60	3.65	3.70	0.142	0.144	0.146	
Н	0.49	0.54	0.59	0.019	0.021	0.023	
K	1.22	1.27	1.32	0.048	0.050	0.052	
K1		0.64 typ.		0.025 typ.			
L	0.49	0.54	0.59	0.019	0.021	0.023	
M1	3.85	3.90	3.95	0.152	0.154	0.156	
M2	2.74	2.79	2.84	0.108	0.110	0.112	
M3	1.06	1.11	1.16	0.042	0.044	0.046	
M4		0.56 typ.		0.022 typ.			
N		8		8			
T1	4.51	4.56	4.61	0.178	0.180	0.182	
T2	2.58	2.63	2.68	0.102	0.104	0.106	
T3	1.88	1.93	1.98	0.074	0.076	0.078	
T4	0.97 typ.			0.038 typ.			
T5	0.48 typ.			0.019 typ.			

DWG: C040

DWG: 6048

Revison: 11-Jul-16

Document Number: 75846



# RECOMMENDED MINIMUM PADS FOR PowerPAK® SO-8 Single



Recommended Minimum Pads Dimensions in Inches/(mm)

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APPLICATION NOTE



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